



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

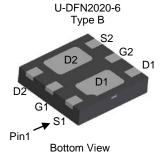
Device	V _{(BR)DSS}	R _{DS(ON)} Max	I _{D Max} T _A = +25°C
0.4		4.0Ω @ V _{GS} = 10V	0.39A
Q1 N-Channel	60V	4.1Ω @ V _{GS} = 5V	0.38A
		4.2Ω @ V _{GS} = 4V	0.37A
00	-20V	$72m\Omega$ @ $V_{GS} = -4.5 V$	-2.9A
Q2 P-Channel		108mΩ @ $V_{GS} = -2.7V$	-2.3A
1 Onamor		123mΩ @ V_{GS} = -2.5 V	-2.2A

Description

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

Load Switch



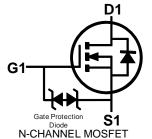


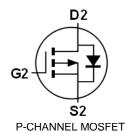
Features

- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Maximum Height
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: U-DFN2020-6 Type B
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @4
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)





Internal Schematic

Ordering Information (Note 5)

Part Number	Case	Packaging
DMC67D8UFDBQ-7	U-DFN2020-6 Type B	3000/Tape & Reel
DMC67D8UFDBQ-13	U-DFN2020-6 Type B	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/. 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.
- Marking Information

Marking Information

7D ywx 7D = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 9 = 2019)

W = Week (ex: a = week 27; z represents week 52 and 53)

X = Internal code (ex: U = Monday)

Date Code Key

Year	2017	2018	2019	2020	2021	2022	2023	2024	2025
Code	7	8	9	0	1	2	3	4	5
	-								

Week	1-26	27-52	53
Code	A-Z	a-z	Z

ſ	Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
ſ	Code	T	U	V	W	X	Y	Z



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Q1 N-Channel	Q2 P-Channel	Unit
Drain-Source Voltage			V_{DSS}	60	-20	V
Gate-Source Voltage			V_{GSS}	±20	±12	V
Continuous Drain Current (Note 7) N-Channel: V _{GS} = 10V P-Channel: V _{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	I _D	0.39 0.31	-2.9 -2.3	А
Maximum Continuous Body Diode Forward Curr	Is	0.39	-2.9	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I _{DM}	0.8	-20	Α		
Pulsed Source Current (10µs Pulse, Duty Cycle	= 1%)		I _{SM}	-0.8	-20	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P _D	0.58	W
Thermal Resistance, Junction to Ambient (Note 6)	R _{OJA}	215	°C/W	
Total Power Dissipation (Note 7)	$T_A = +25^{\circ}C$	P _D	0.89	W
Thermal Resistance, Junction to Ambient (Note 7)	Reja	140	°C/W	
Thermal Resistance, Junction to Case (Note 7)	R _{eJC}	35	C/VV	
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C	

Electrical Characteristics: Q1 N-Channel (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	Cymbol		тур	Wax	Oint	rest condition	
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V, I_D = 10\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1.0	μΑ	V _{DS} = 60V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)				•	•		
Gate Threshold Voltage	V _{GS(TH)}	1.0	_	2.5	>	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
			1.7	4.0		$V_{GS} = 10V, I_D = 0.5A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	1.6	4.1	Ω	$V_{GS} = 5V, I_D = 0.2A$	
			1.8	4.2		$V_{GS} = 4V, I_D = 0.2A$	
Diode Forward Voltage	V _{SD}	_	0.8	1.1	V	V _{GS} = 0V, I _S = 115mA	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}		41		рF	\\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Output Capacitance	Coss		4.4	1	рF	$V_{DS} = 25V, V_{GS} = 0V$ f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}		2.6	_	pF	1 - 1.000112	
Gate Resistance	Rg	_	900	_	Ω	$f = 1MHz$, $V_{GS} = 0V$, $V_{DS} = 0V$	
Total Gate Charge	Qg	_	0.4	_	рC	457777 4077	
Gate-Source Charge	Q_{gs}	_	0.2	_	рC	$V_{GS} = 4.5V, V_{DS} = 10V,$	
Gate-Drain Charge	Q_{gd}	_	0.1	_	рC	I _D = 250mA	
Turn-On Delay Time	t _{D(ON)}	_	3.7	_	ns		
Turn-On Rise Time	t _R	_	3.6	_	ns	$V_{DD} = 30V, V_{GS} = 10V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	102	_	ns	$R_g = 25\Omega, I_D = 200 \text{mA}$	
Turn-Off Fall Time	t _F	_	22	_	ns		
Reverse Recovery Time	t _{RR}	_	20	_	ns	I _F = 1A, di/dt = 100A/μs	
Reverse Recovery Charge	Q_{RR}	_	7.9	_	nC	I _F = 1A, di/dt = 100A/μs	



Electrical Characteristics: Q2 P-Channel (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$I_D = -250 \mu A, V_{GS} = 0 V$
Zero Gate Voltage Drain Current	I _{DSS}	_		-1	μA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Body Leakage Current	I _{GSS}	_		±100	nA	$V_{DS} = 0V, V_{GS} = \pm 12V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	-0.6	_	-1.25	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
			51	72		$V_{GS} = -4.5V$, $I_D = -3.5A$
Static Drain-Source On-Resistance	R _{DS(ON)}		87	108	mΩ	$V_{GS} = -2.7V$, $I_{D} = -3.0A$
			99	123		$V_{GS} = -2.5V$, $I_D = -2.6A$
Diode Forward Voltage	V_{SD}	_	-0.79	-1.26	V	$I_S = -1.7A$, $V_{GS} = 0V$
DYNAMIC PARAMETERS (Note 9)	<u>.</u>					
Total Gate Charge	Qg	_	7.3	_	nC	$V_{GS} = -4.5V$, $V_{DS} = -10V$, $I_D = -3.0A$
Gate-Source Charge	Q_{gs}	_	2.0	_	nC	$V_{GS} = -4.5V$, $V_{DS} = -10V$, $I_D = -3.0A$
Gate-Drain Charge	Q_{gd}	_	1.9	_	nC	$V_{GS} = -4.5V$, $V_{DS} = -10V$, $I_D = -3.0A$
Turn-On Delay Time	t _{D(on)}	_	12	_	ns	
Turn-On Rise Time	t _r	_	20	_	ns	$V_{DS} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(off)}	_	38	_	ns	$R_L = 10\Omega$, $R_G = 6\Omega$
Turn-Off Fall Time	t _f	_	41	_	ns	
Input Capacitance	C _{iss}		443	_	pF	101/11/
Output Capacitance	Coss	_	128	_	pF	$V_{DS} = -16V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	101	_	pF	71 — 1.0IVII 12

- 6. Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
 7. Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.
 8. Short duration pulse test used to minimize self-heating effect.

- 9. Guaranteed by design. Not subject to product testing.



Typical Characteristics: N-Channel

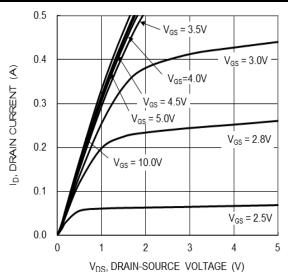


Figure 1. Typical Output Characteristic

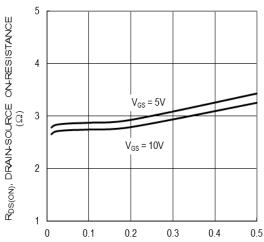


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

ID, DRAIN-SOURCE CURRENT (A)

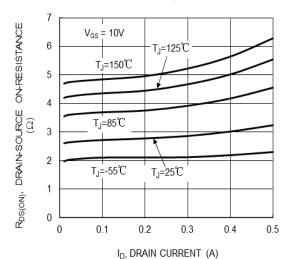
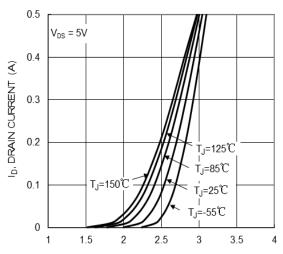
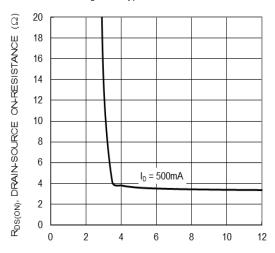


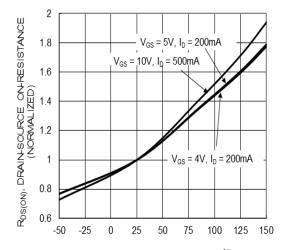
Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 4. Typical Transfer Characteristic



T_J, JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Junction Temperature



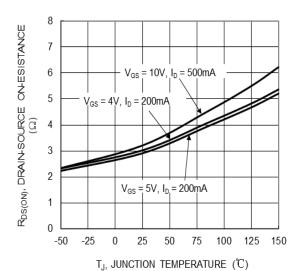
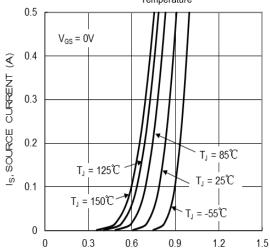


Figure 7. On-Resistance Variation with Junction Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

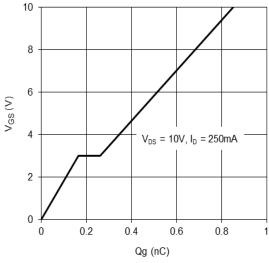


Figure 11. Gate Charge

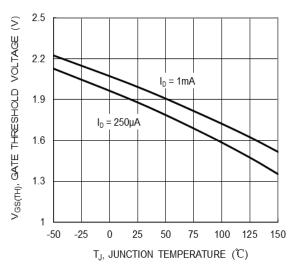
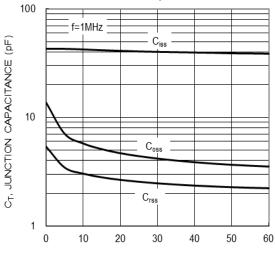
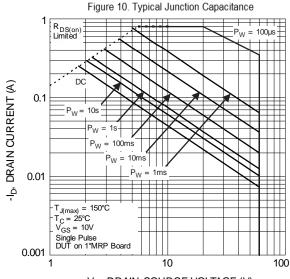


Figure 8. Gate Threshold Variation vs. Junction Temperature



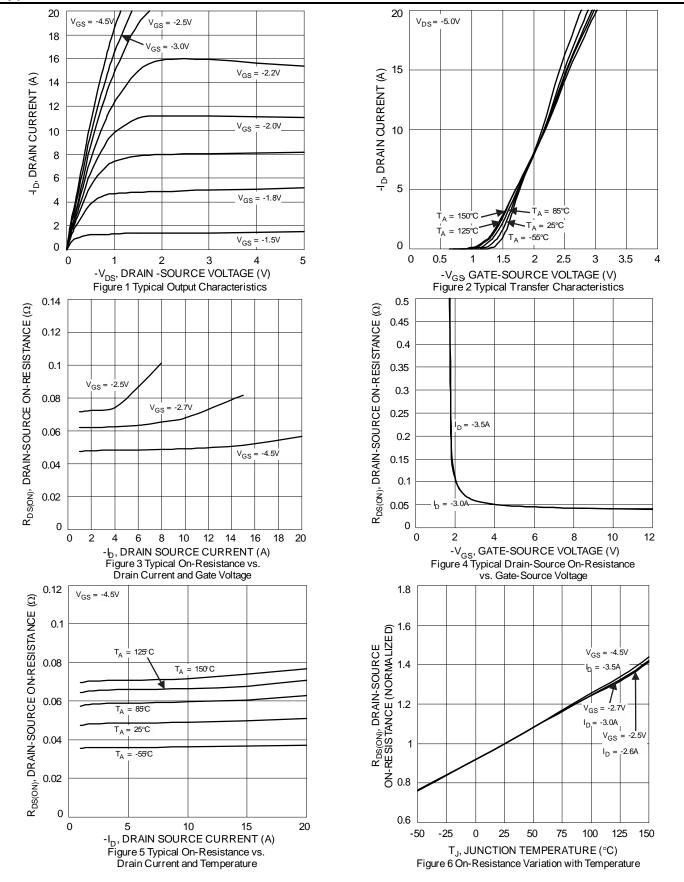
 V_{DS} , DRAIN-SOURCE VOLTAGE (V)



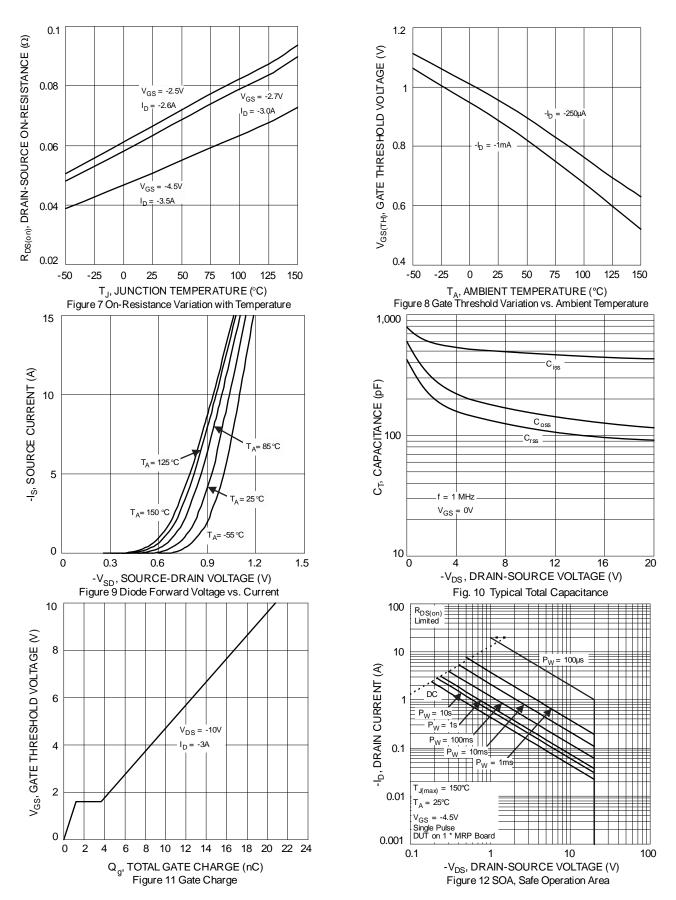
-V_{DS} DRAIN-SOURCE VOLTAGE (V) Figure 12 SOA, Safe Operation Area



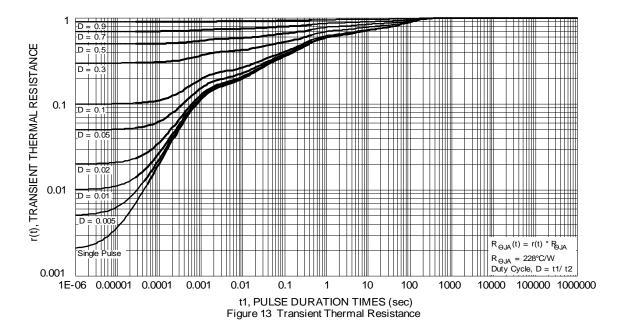
Typical Characteristics: P-Channel







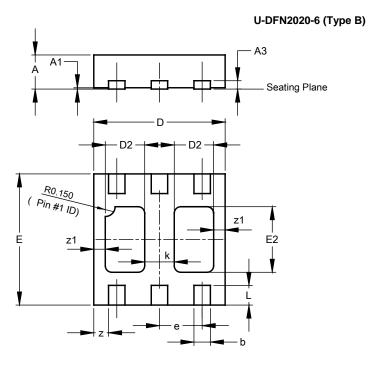






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

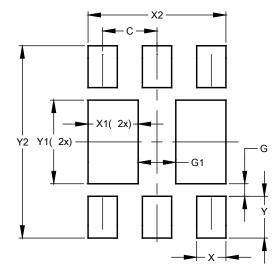


U-DFN2020-6 Type B							
Dim	Min	Max	Тур				
Α	0.545	0.605	0.575				
A1	0.00	0.05	0.02				
A3	-	-	0.13				
b	0.20	0.30	0.25				
D	1.95	2.075	2.00				
D2	0.50	0.70	0.60				
е	-	-	0.65				
Е	1.95	2.075	2.00				
E2	0.90	1.10	1.00				
k	-	-	0.45				
L	0.25	0.35	0.30				
Z	-	-	0.225				
z1	-	-	0.175				
All	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type B)



Dimensions	Value (in mm)
С	0.650
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Y	0.500
Y1	1.000
Y2	2 300



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